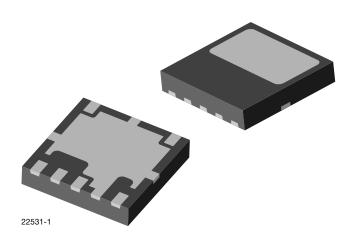


RoHS

HALOGEN FREE

GREEN

IR Receiver Modules for Remote Control Systems



LINKS TO ADDITIONAL RESOURCES









DESCRIPTION

The TSOP573.., TSOP575.. series are miniaturized receiver modules for infrared remote control systems. A PIN diode and a preamplifier are assembled on a lead frame, the epoxy lens cap contains an IR filter. The demodulated output signal can be directly connected to a microprocessor for decoding.

The TSOP573.. series devices are optimized to suppress almost all spurious pulses from Wi-Fi and CFL sources. They may suppress some data signals if continuously transmitted.

New designs should prefer the TSOP573.. series containing the newer AGC3. The TSOP575.. series are useful to suppress even extreme levels of optical noise, but may also suppress some data signals. Please check compatibility with your codes.

These components have not been qualified according to automotive specifications.

FEATURES

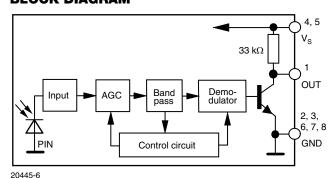
- · Improved immunity against HF and RF noise
- · Height of 0.8 mm
- ± 75° half angle sensitivity
- Low supply current
- Photo detector and preamplifier in one package
- Suitable for all common data formats including those for short bursts
- Supply voltage: 2.5 V to 5.5 V
- Improved immunity against ambient light
- Insensitive to supply voltage ripple and noise
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

ORDERING CODE

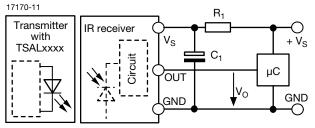
Taping:

TSOP57...TT1 - top view taped, 1800 pcs/reel

BLOCK DIAGRAM



APPLICATION CIRCUIT



 R_1 and C_1 recommended to reduce supply ripple for $V_S < 2.8 \text{ V}$



PARTS TABLE					
AGC		NOISY ENVIRONMENTS AND SHORT BURSTS (AGC3)	VERY NOISY ENVIRONMENTS AND SHORT BURSTS (AGC5)		
Carrier frequency	36 kHz	TSOP57336 (1)	TSOP57536		
	38 kHz	TSOP57338 (2)(3)(4)(5)	TSOP57538		
	40 kHz	TSOP57340	TSOP57540		
	56 kHz	TSOP57356	TSOP57556		
Package		Belobog			
Pinning		1 = OUT, 2, 3, 6, 7, 8 = GND, 4, 5 = V _S			
Dimensions (mm)		3.95 W x 3.95 H x 0.8 D			
Mounting		SMD			
Application		Remote control			
Best choice for		(1) MCIR (2) Mitsubishi (3) RECS-80 Code (4) x-map (5) XMP-1, XMP-2			
Special options		Extended temperature range: <u>www.vishay.com/doc?82738</u>			

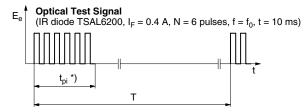
ABSOLUTE MAXIMUM RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		V _S	-0.3 to +6	V
Supply current		I _S	5	mA
Output voltage		Vo	-0.3 to (V _S + 0.3)	V
Output current		l _O	5	mA
Junction temperature		Tj	100	°C
Storage temperature range		T _{stg}	-25 to +85	°C
Operating temperature range		T _{amb}	-25 to +85	°C
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW

Note

• Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability

ELECTRICAL AND OPTICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		Vs	2.5	1	5.5	V
Supply current	$V_{S} = 5 V, E_{v} = 0$	I _{SD}	0.55	0.7	0.9	mA
Supply current	$E_v = 40 \text{ klx, sunlight}$	I _{SH}	-	0.8	-	mA
Transmission distance	$E_{\rm v}=0,$ IR diode TSAL6200, I _F = 50 mA, test signal see Fig. 1	d	-	18	-	m
Output voltage low	$I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2,$ test signal see Fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	Pulse width tolerance: t_{pi} - $5/f_o < t_{po} < t_{pi} + 6/f_{o,}$ test signal see Fig. 1	E _{e min.}	-	0.2	0.4	mW/m²
Maximum irradiance	t_{pi} - 5/f _o < t_{po} < t_{pi} + 6/f _o , test signal see Fig. 1	E _{e max.}	50	-	-	W/m ²
Directivity	Angle of half transmission distance	Ψ1/2	-	± 75	-	deg

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)



*) $t_{pi} \ge 6/f_0$ is recommended for optimal function

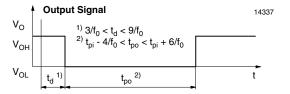


Fig. 1 - Output Active Low

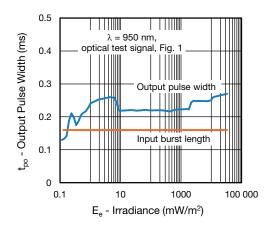
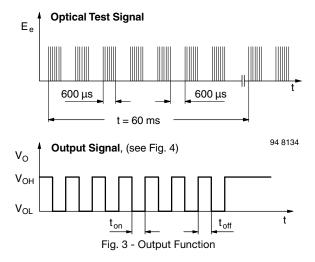


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient



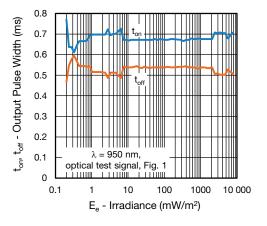


Fig. 4 - Output Pulse Diagram

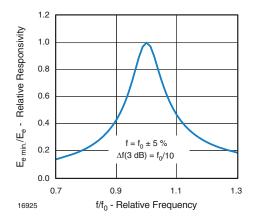


Fig. 5 - Frequency Dependance of Responsivity

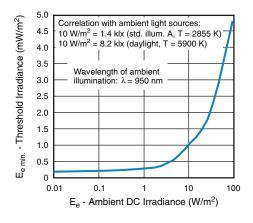


Fig. 6 - Sensitivity in Bright Ambient

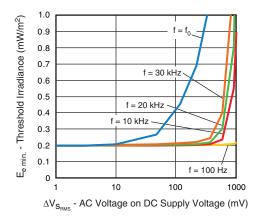


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

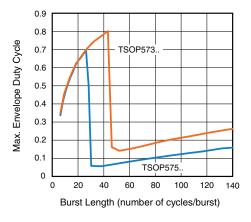


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

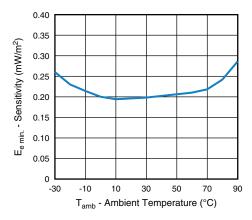


Fig. 9 - Sensitivity vs. Ambient Temperature

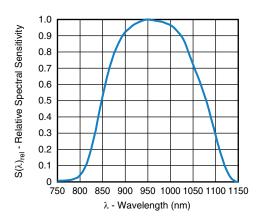


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

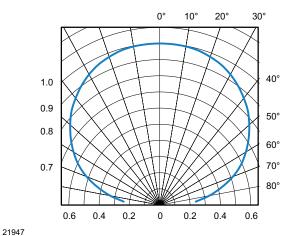


Fig. 11 - Horizontal Directivity

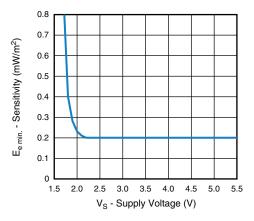


Fig. 12 - Sensitivity vs. Supply Voltage



SUITABLE DATA FORMAT

The TSOP573.., TSOP575.. series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the TSOP573.., TSOP575.. in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output. Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- · Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see Fig. 13 or Fig. 14)
- 2.4 GHz and 5 GHz Wi-Fi

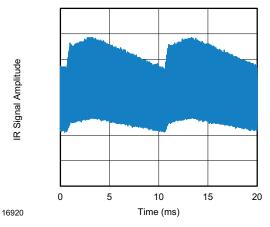


Fig. 13 - IR Signal from Fluorescent Lamp With Low Modulation

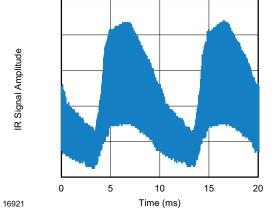


Fig. 14 - IR Signal from Fluorescent Lamp With High Modulation

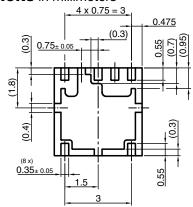
	TSOP573	TSOP575
Minimum burst length	6 cycles/burst	6 cycles/burst
After each burst of length a minimum gap time is required of	6 to 35 cycles ≥ 10 cycles	6 to 24 cycles ≥ 10 cycles
For bursts greater than a minimum gap time in the data stream is needed of	35 cycles > 6 x burst length	24 cycles > 25 ms
Maximum number of continuous short bursts/second	2000	2000
MCIR code	Preferred	Yes
XMP-1, XMP-2 code	Preferred	Yes
Suppression of interference from fluorescent lamps	Mild and complex disturbance patterns are suppressed (example: signal pattern of Fig. 13 and Fig. 14)	Critical disturbance patterns are suppressed, e.g. highly dimmed LCDs

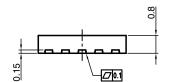
Note

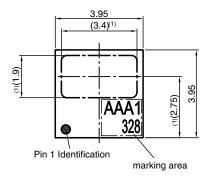
• For data formats with long bursts (more than 10 carrier cycles) please see the datasheet for TSOP572.., TSOP574..



PACKAGE DIMENSIONS in millimeters



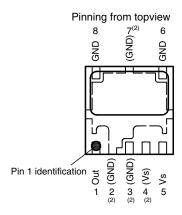




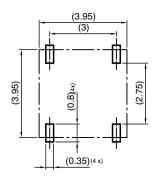
Drawing-No.: 6.550-5315.01-4 Issue: 2; 12.02.14

Not indicated tolerances ± 0.1

technical drawings according to DIN specifications



Proposed pad layout from component side (dim. for reference only)



Notes

(1) Optically effective area

(2) Pins connected internally. It is not necessary to connect externally

ASSEMBLY INSTRUCTIONS

Reflow Soldering

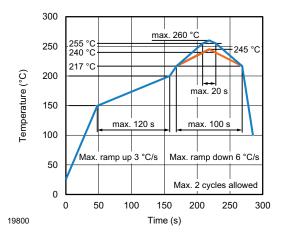
- Reflow soldering must be done within 168 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured

 Handling after reflow should be done only after the work surface has been cooled off

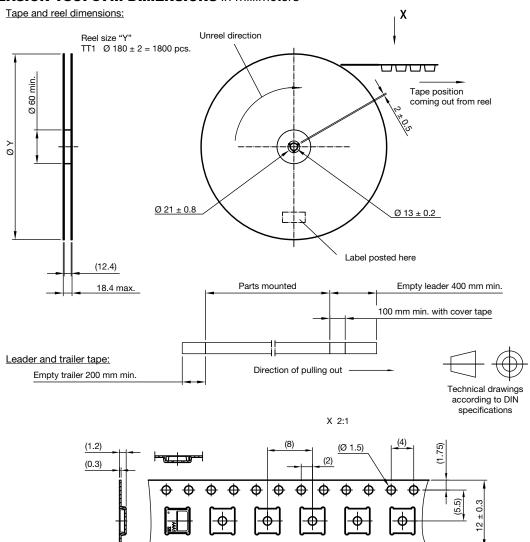
Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSOP57... DIMENSIONS in millimeters



Drawing-No.: 9.700-5347.01-4

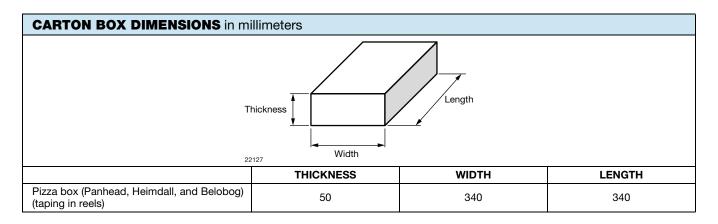
Issue: 2; 07.03.18

Not indicated tolerances ± 0.1



OUTER PACKAGING

The sealed reel is packed into a pizza box.



LABEL

Standard bar code labels for finished goods

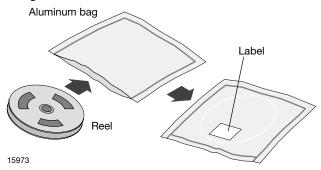
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)				
PLAIN WRITING	ABBREVIATION	LENGTH		
Item-description	-	18		
Item-number	INO	8		
Selection-code	SEL	3		
LOT-/serial-number	BATCH	10		
Data-code	COD	3 (YWW)		
Plant-code	PTC	2		
Quantity	QTY	8		
Accepted by	ACC	-		
Packed by	PCK	-		
Mixed code indicator	MIXED CODE	-		
Origin	XXXXXXX+	Company logo		
LONG BAR CODE TOP	TYPE	LENGTH		
Item-number	N	8		
Plant-code	N	2		
Sequence-number	X	3		
Quantity	N	8		
Total length	-	21		
SHORT BAR CODE BOTTOM	TYPE	LENGTH		
Selection-code	Х	3		
Data-code	N	3		
Batch-number	X	10		
Filter	-	1		
Total length	-	17		



DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

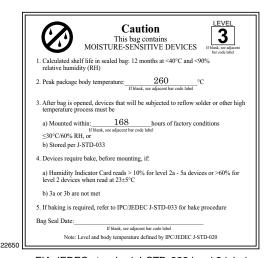
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 3 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 3 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

BAR CODE PRODUCT LABEL (example)



2217



Legal Disclaimer Notice

Vishay

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